3μA I_Q, 20mA Low Dropout Linear Regulators

FEATURES

- **Ultralow Quiescent Current: 3μA**
- **Input Voltage Range: 1.6V to 20V**
- **Output Current: 20mA**
- **Dropout Voltage: 280mV**
- **Adjustable Output (V_{ADJ} = $V_{OUT(MIN)}$ = 600mV)**
- **Fixed Output Voltages: 1.2V, 1.5V, 1.8V, 2.5V, 3.3V, 5V**
- Output Tolerance: ±2% Over Load, Line and Temperature
- Stable with Low ESR, Ceramic Output Capacitors (1μF minimum)
- Shutdown Current: <1μA
- Current Limit Protection
- Reverse-Battery Protection
- Thermal Limit Protection
- 8-Lead SC70 and 2mm × 2mm DFN Packages

APPLICATIONS

- Low Current Battery-Powered Systems
- Keep-Alive Power Supplies
- Remote Monitoring
  - Utility Meters
  - Hotel Door Locks

DESCRIPTION

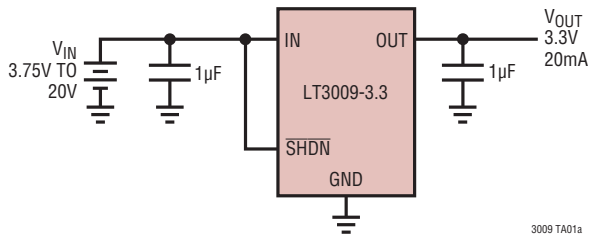
The LT®3009 Series are micropower, low dropout voltage (LDO) linear regulators. The devices supply 20mA output current with a dropout voltage of 280mV. No-load quiescent current is 3μA. Ground pin current remains at less than 5% of output current as load increases. In shutdown, quiescent current is less than 1μA.

The LT3009 regulators optimize stability and transient response with low ESR ceramic capacitors, requiring a minimum of only 1μF. The regulators do not require the addition of ESR as is common with other regulators. Internal protection circuitry includes current limiting, thermal limiting, reverse-battery protection and reverse-current protection.

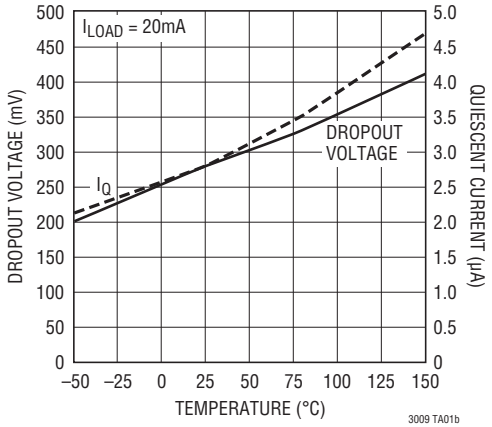
The LT3009 Series are ideal for applications that require moderate output drive capability coupled with ultralow standby power consumption. The device is available in fixed output voltages of 1.2V, 1.5V, 1.8V, 2.5V, 3.3V and 5V, and as an adjustable device with an output voltage range down to the 600mV reference. The LT3009 is available in the 6-lead DFN and 8-lead SC70 packages.

TYPICAL APPLICATION

3.3V, 20mA Supply with Shutdown



Dropout Voltage/Quiescent Current



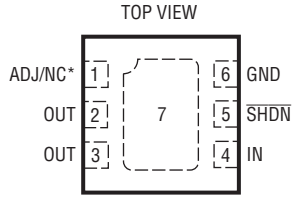
ABSOLUTE MAXIMUM RATINGS

(Note 1)

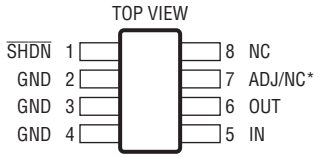
IN Pin Voltage ..... ±22V
OUT Pin Voltage ..... ±22V
Input-to-Output Differential Voltage ..... ±22V
ADJ Pin Voltage ..... ±22V
$\overline{SHDN}$ Pin Voltage (Note 8) ..... ±22V
Output Short-Circuit Duration ..... Indefinite

Operating Junction Temperature Range (Notes 2, 3)
(E, I Grades) ..... –40°C to 125°C
Storage Temperature Range ..... –65°C to 150°C
Lead Temperature: Soldering, 10 sec
SC8 Package Only ..... 300°C

PIN CONFIGURATION



DC PACKAGE
6-LEAD (2mm × 2mm) PLASTIC DFN
T_{JMAX} = 125°C, θ_{JA} = 65°C/W TO 85°C/W**
EXPOSED PAD (PIN 7) IS GND, MUST BE SOLDERED TO PCB



SC8 PACKAGE
8-LEAD PLASTIC SC70
T_{JMAX} = 125°C, θ_{JA} = 75°C/W TO 95°C/W**

* The ADJ pin is not connected in fixed output voltage versions.
** See the Applications Information section.

ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT3009EDC#PBF	LT3009EDC#TRPBF	LCQX	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC#PBF	LT3009IDC#TRPBF	LCQX	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009EDC-1.2#PBF	LT3009EDC-1.2#TRPBF	LDTW	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC-1.2#PBF	LT3009IDC-1.2#TRPBF	LDTW	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009EDC-1.5#PBF	LT3009EDC-1.5#TRPBF	LDVB	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC-1.5#PBF	LT3009IDC-1.5#TRPBF	LDVB	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009EDC-1.8#PBF	LT3009EDC-1.8#TRPBF	LDKC	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC-1.8#PBF	LT3009IDC-1.8#TRPBF	LDKC	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009EDC-2.5#PBF	LT3009EDC-2.5#TRPBF	LDTY	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC-2.5#PBF	LT3009IDC-2.5#TRPBF	LDTY	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009EDC-3.3#PBF	LT3009EDC-3.3#TRPBF	LDKD	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC-3.3#PBF	LT3009IDC-3.3#TRPBF	LDKD	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009EDC-5#PBF	LT3009EDC-5#TRPBF	LDKF	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC-5#PBF	LT3009IDC-5#TRPBF	LDKF	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C

ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT3009ESC8#PBF	LT3009ESC8#TRPBF	LCQY	8-Lead Plastic SC70	–40°C to 125°C
LT3009ESC8-1.2#PBF	LT3009ESC8-1.2#TRPBF	LDTX	8-Lead Plastic SC70	–40°C to 125°C
LT3009ESC8-1.5#PBF	LT3009ESC8-1.5#TRPBF	LDVC	8-Lead Plastic SC70	–40°C to 125°C
LT3009ESC8-1.8#PBF	LT3009ESC8-1.8#TRPBF	LDKG	8-Lead Plastic SC70	–40°C to 125°C
LT3009ESC8-2.5#PBF	LT3009ESC8-2.5#TRPBF	LDTZ	8-Lead Plastic SC70	–40°C to 125°C
LT3009ESC8-3.3#PBF	LT3009ESC8-3.3#TRPBF	LDKH	8-Lead Plastic SC70	–40°C to 125°C
LT3009ESC8-5#PBF	LT3009ESC8-5#TRPBF	LDKJ	8-Lead Plastic SC70	–40°C to 125°C
LEAD BASED FINISH	**TAPE AND REEL**	**PART MARKING***	**PACKAGE DESCRIPTION**	**TEMPERATURE RANGE**
LT3009EDC	LT3009EDC#TR	LCQX	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC	LT3009IDC#TR	LCQX	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009EDC-1.2	LT3009EDC-1.2#TR	LDTW	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC-1.2	LT3009IDC-1.2#TR	LDTW	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009EDC-1.5	LT3009EDC-1.5#TR	LDVB	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC-1.5	LT3009IDC-1.5#TR	LDVB	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009EDC-1.8	LT3009EDC-1.8#TR	LDKC	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC-1.8	LT3009IDC-1.8#TR	LDKC	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009EDC-2.5	LT3009EDC-2.5#TR	LDTY	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC-2.5	LT3009IDC-2.5#TR	LDTY	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009EDC-3.3	LT3009EDC-3.3#TR	LDKD	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC-3.3	LT3009IDC-3.3#TR	LDKD	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009EDC-5	LT3009EDC-5#TR	LDKF	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009IDC-5	LT3009IDC-5#TR	LDKF	6-Lead (2mm × 2mm) Plastic DFN	–40°C to 125°C
LT3009ESC8	LT3009ESC8#TR	LCQY	8-Lead Plastic SC70	–40°C to 125°C
LT3009ESC8-1.2	LT3009ESC8-1.2#TR	LDTX	8-Lead Plastic SC70	–40°C to 125°C
LT3009ESC8-1.5	LT3009ESC8-1.5#TR	LDVC	8-Lead Plastic SC70	–40°C to 125°C
LT3009ESC8-1.8	LT3009ESC8-1.8#TR	LDKG	8-Lead Plastic SC70	–40°C to 125°C
LT3009ESC8-2.5	LT3009ESC8-2.5#TR	LDTZ	8-Lead Plastic SC70	–40°C to 125°C
LT3009ESC8-3.3	LT3009ESC8-3.3#TR	LDKH	8-Lead Plastic SC70	–40°C to 125°C
LT3009ESC8-5	LT3009ESC8-5#TR	LDKJ	8-Lead Plastic SC70	–40°C to 125°C

Consult LTC Marketing for parts specified with wider operating temperature ranges. *The temperature grade is identified by a label on the shipping container.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/
For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_J = 25°C. (Note 2)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Operating Voltage		●	1.6		20	V
Regulated Output Voltage (Note 4)	LT3009-1.2: V_{IN} = 1.7V, I_{LOAD} = 100µA		1.188	1.2	1.212	V
	1.7V < V_{IN} < 20V, 1µA < I_{LOAD} < 20mA	●	1.176	1.2	1.224	V
	LT3009-1.5: V_{IN} = 2V, I_{LOAD} = 100µA		1.485	1.5	1.515	V
	2V < V_{IN} < 20V, 1µA < I_{LOAD} < 20mA	●	1.470	1.5	1.530	V
	LT3009-1.8: V_{IN} = 2.3V, I_{LOAD} = 100µA		1.782	1.8	1.818	V
	2.3V < V_{IN} < 20V, 1µA < I_{LOAD} < 20mA	●	1.764	1.8	1.836	V
	LT3009-2.5: V_{IN} = 3V, I_{LOAD} = 100µA		2.475	2.5	2.525	V
	3V < V_{IN} < 20V, 1µA < I_{LOAD} < 20mA	●	2.45	2.5	2.55	V
	LT3009-3.3: V_{IN} = 3.8V, I_{LOAD} = 100µA		3.267	3.3	3.333	V
	3.8V < V_{IN} < 20V, 1µA < I_{LOAD} < 20mA	●	3.234	3.3	3.366	V
	LT3009-5: V_{IN} = 5.5V, I_{LOAD} = 100µA		4.950	5	5.050	V
	3.8V < V_{IN} < 20V, 1µA < I_{LOAD} < 20mA	●	4.900	5	5.100	V
ADJ Pin Voltage (Notes 3, 4)	V_{IN} = 1.6V, I_{LOAD} = 100µA		594	600	606	mV
	1.6V < V_{IN} < 20V, 1µA < I_{LOAD} < 20mA	●	588	600	612	mV
Line Regulation (Note 3)	LT3009-1.2: □V_{IN} = 1.7V to 20V, I_{LOAD} = 1mA	●		0.8	3.0	mV
	LT3009-1.5: □V_{IN} = 2.0V to 20V, I_{LOAD} = 1mA	●		1.0	3.8	mV
	LT3009-1.8: □V_{IN} = 2.3V to 20V, I_{LOAD} = 1mA	●		1.2	4.5	mV
	LT3009-2.5: □V_{IN} = 3.0V to 20V, I_{LOAD} = 1mA	●		1.7	6.3	mV
	LT3009-3.3: □V_{IN} = 3.8V to 20V, I_{LOAD} = 1mA	●		2.2	8.3	mV
	LT3009-5: □V_{IN} = 5.5V to 20V, I_{LOAD} = 1mA	●		3.3	12.5	mV
	LT3009: □V_{IN} = 1.6V to 20V, I_{LOAD} = 1mA	●		0.4	1.5	mV
Load Regulation (Note 3)	LT3009-1.2: V_{IN} = 1.7V, I_{LOAD} = 1µA to 20mA	●		1.4	6	mV
	LT3009-1.5: V_{IN} = 2V, I_{LOAD} = 1µA to 20mA	●		1.8	7.5	mV
	LT3009-1.8: V_{IN} = 2.3V, I_{LOAD} = 1µA to 20mA	●		2.1	9.0	mV
	LT3009-2.5: V_{IN} = 3V, I_{LOAD} = 1µA to 20mA	●		2.9	12.5	mV
	LT3009-3.3: V_{IN} = 3.8V, I_{LOAD} = 1µA to 20mA	●		3.9	16.5	mV
	LT3009-5: V_{IN} = 5.5V, I_{LOAD} = 1µA to 20mA	●		5.8	25	mV
	LT3009: V_{IN} = 1.6V, I_{LOAD} = 1µA to 20mA	●		0.7	3	mV
Dropout Voltage V_{IN} = $V_{OUT(NOMINAL)}$ (Notes 5, 6)	I_{LOAD} = 100µA			115	180	mV
	I_{LOAD} = 100µA	●			250	mV
	I_{LOAD} = 1mA			170	250	mV
	I_{LOAD} = 1mA	●			350	mV
	I_{LOAD} = 10mA			250	310	mV
	I_{LOAD} = 10mA	●			410	mV
	I_{LOAD} = 20mA			280	350	mV
	I_{LOAD} = 20mA	●			450	mV
Quiescent Current (Notes 6, 7)	I_{LOAD} = 0µA			3		µA
	I_{LOAD} = 0µA	●			6	µA
GND Pin Current V_{IN} = $V_{OUT(NOMINAL)}$ + 0.5V (Notes 6, 7)	I_{LOAD} = 0µA	●		3	6	µA
	I_{LOAD} = 100µA	●		6	12	µA
	I_{LOAD} = 1mA	●		23	50	µA
	I_{LOAD} = 10mA	●		200	500	µA
	I_{LOAD} = 20mA	●		450	1000	µA

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_J = 25°C. (Note 2)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Output Voltage Noise (Note 9)	C_{OUT} = 1µF, I_{LOAD} = 20mA, BW = 10Hz to 100kHz			150		μV_{RMS}
ADJ Pin Bias Current		●	–10	0.3	10	nA
Shutdown Threshold	V_{OUT} = Off to On V_{OUT} = On to Off	● ●	 0.2	0.66 0.36	1.5	V V
$\overline{SHDN}$ Pin Current	$V_{\overline{SHDN}}$ = 0V, V_{IN} = 20V $V_{\overline{SHDN}}$ = 20V, V_{IN} = 20V	● ●		 0.5	±1 1.6	µA µA
Quiescent Current in Shutdown	V_{IN} = 6V, $V_{\overline{SHDN}}$ = 0V	●			<1	µA
Ripple Rejection (Note 3)	$V_{IN} – V_{OUT}$ = 1.5V, V_{RIPPLE} = 0.5V_{P-P}, f_{RIPPLE} = 120Hz, I_{LOAD} = 20mA					
	LT3009		60	72		dB
	LT3009-1.2		57	68		dB
	LT3009-1.5		55.5	67		dB
	LT3009-1.8		54	66		dB
	LT3009-2.5		52	63		dB
	LT3009-3.3		49	61		dB
	LT3009-5		44	56		dB
Current Limit	V_{IN} = 20V, V_{OUT} = 0 V_{IN} = $V_{OUT(NOMINAL)}$ + 1V, □V_{OUT} = –5%	 ●	 22	60		mA mA
Input Reverse Leakage Current	V_{IN} = –20V, V_{OUT} = 0	●		200	350	µA
Reverse Output Current	V_{OUT} = 1.2V, V_{IN} = 0			0.6	10	µA

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: The LT3009 regulators are tested and specified under pulse load conditions such that $T_J \approx T_A$. The LT3009E is guaranteed to meet performance specifications from 0°C to 125°C operating junction temperature. Specifications over the –40 °C to 125°C operating junction temperature range are assured by design, characterization and correlation with statistical process controls. The LT3009I is guaranteed over the full –40°C to 125°C operating junction temperature range.

Note 3: The LT3009 adjustable version is tested and specified for these conditions with the ADJ pin connected to the OUT pin.

Note 4: Operating conditions are limited by maximum junction temperature. The regulated output voltage specification will not apply for all possible combinations of input voltage and output current. When operating at the maximum input voltage, the output current range must be limited. When operating at the maximum output current, the input voltage must be limited.

Note 5: Dropout voltage is the minimum input to output voltage differential needed to maintain regulation at a specified output current. In dropout, the output voltage equals ($V_{IN} – V_{DROPOUT}$). For the LT3009-1.2, dropout voltage will be limited by the minimum input voltage under some voltage/load conditions.

Note 6: To satisfy minimum input voltage requirements, the LT3009 adjustable version is tested and specified for these conditions with an external resistor divider (61.9k bottom, 280k top) which sets V_{OUT} to 3.3V. The external resistor divider adds 9.69µA of DC load on the output. This external current is not factored into GND pin current.

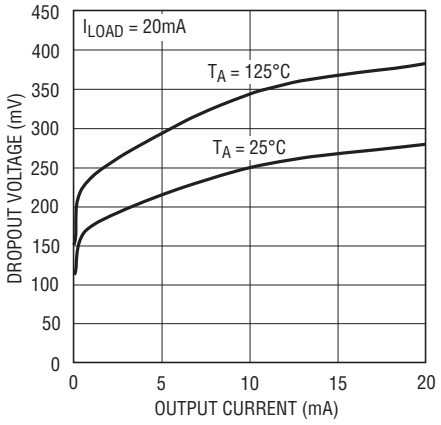
Note 7: GND pin current is tested with V_{IN} = $V_{OUT(NOMINAL)}$ + 0.5V and a current source load. GND pin current will increase in dropout. For the fixed output voltage versions, an internal resistor divider will add to the GND pin current (□2µA for the LT3009-5, □1µA for the LT3009-1.2, LT3009-1.5, LT3009-1.8, LT3009-2.5 and LT3009-3.3). See the GND Pin Current curves in the Typical Performance Characteristics section.

Note 8: The $\overline{SHDN}$ pin can be driven below GND only when tied to the IN pin directly or through a pull-up resistor. If the $\overline{SHDN}$ pin is driven below GND by more than –0.3V while IN is powered, the output will turn on.

Note 9: Output noise is listed for the adjustable version with the ADJ pin connected to the OUT pin. See the RMS Output Noise vs Load Current curve in the Typical Performance Characteristics Section.

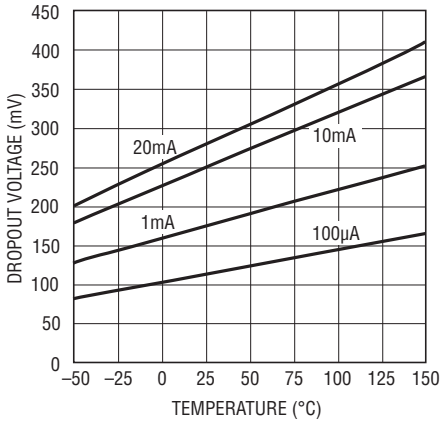
TYPICAL PERFORMANCE CHARACTERISTICS T_A = 25°C, unless otherwise noted.

Dropout Voltage



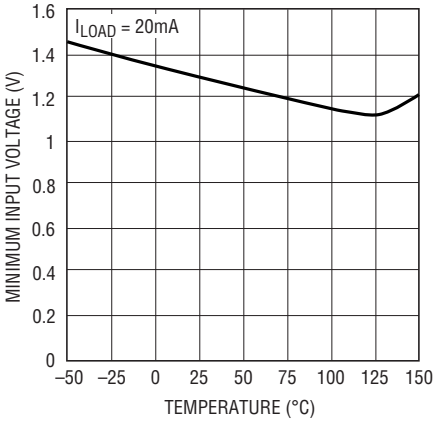
3009 G01

Dropout Voltage



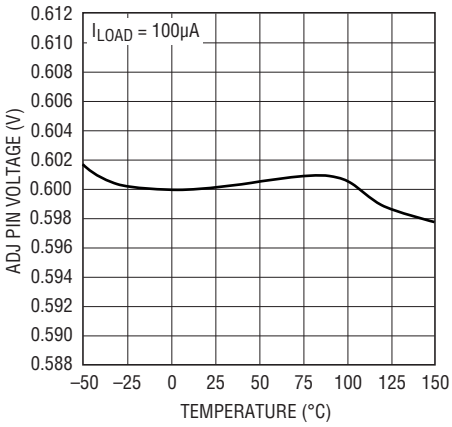
3009 G02

Minimum Input Voltage



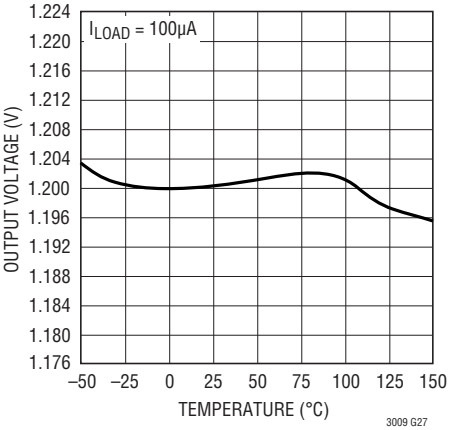
3009 G03

ADJ Pin Voltage



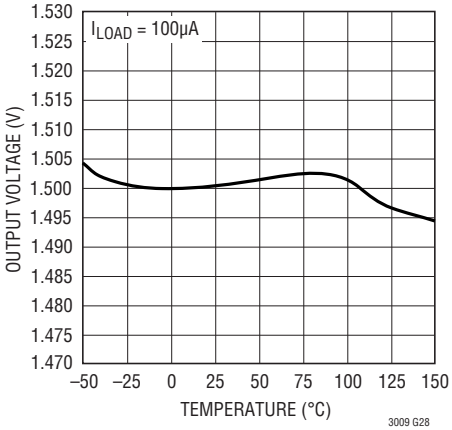
3009 G04

Output Voltage LT3009-1.2



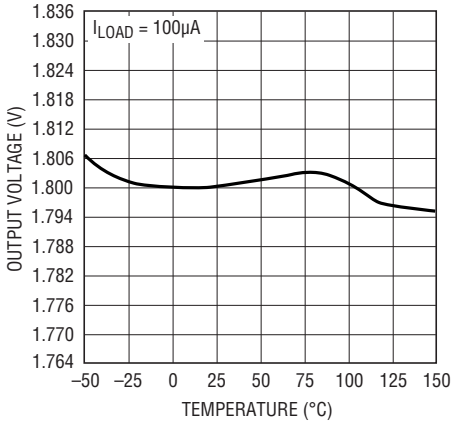
3009 G27

Output Voltage LT3009-1.5



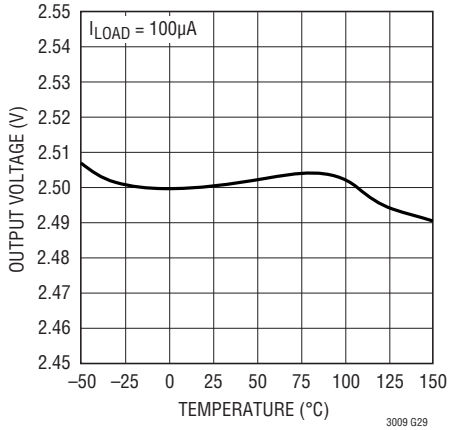
3009 G28

Output Voltage LT3009-1.8



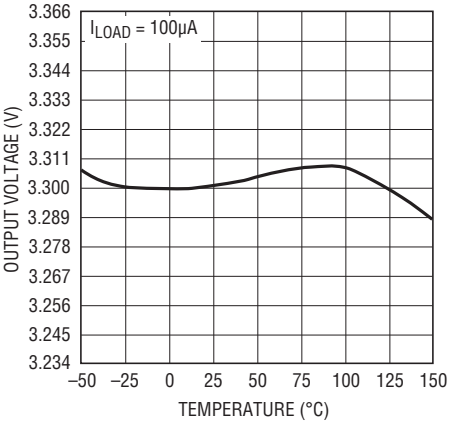
3009 G05

Output Voltage LT3009-2.5



3009 G29

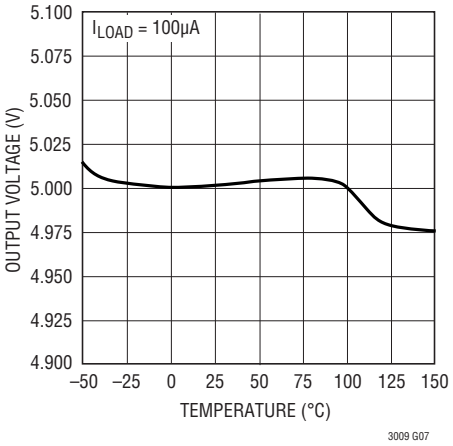
Output Voltage LT3009-3.3



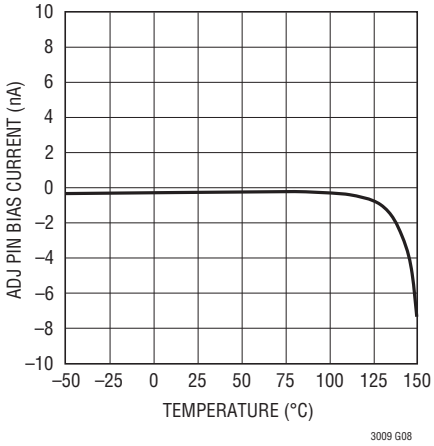
3009 G06

TYPICAL PERFORMANCE CHARACTERISTICS T_A = 25°C, unless otherwise noted.

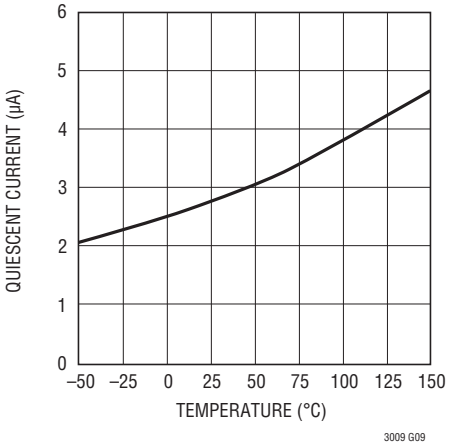
Output Voltage
LT3009-5



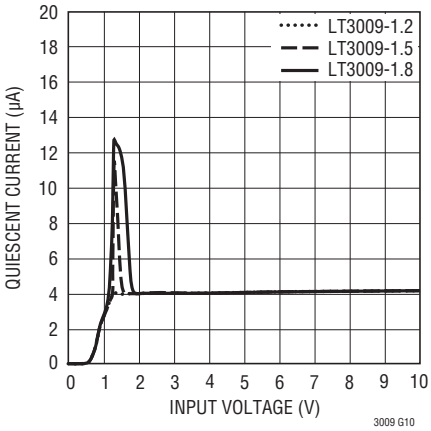
ADJ Pin Bias Current



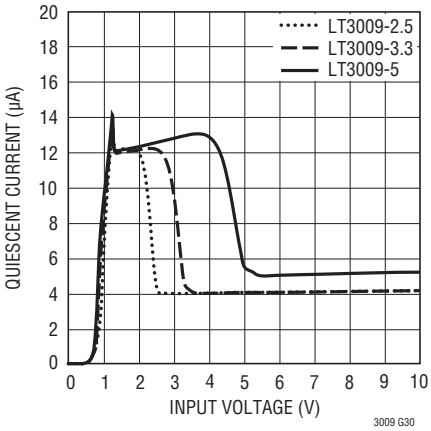
Adjustable Version
Quiescent Current



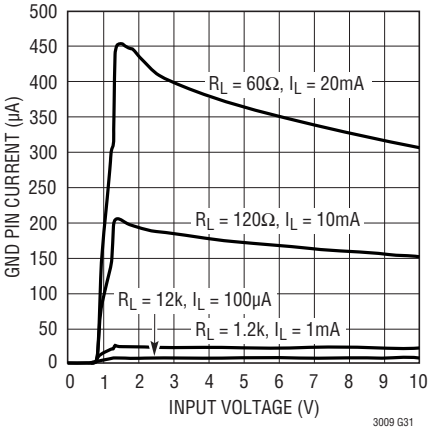
Quiescent Current



Quiescent Current

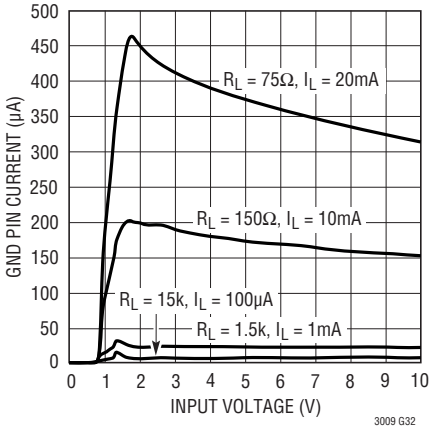


GND Pin Current
LT3009-1.2

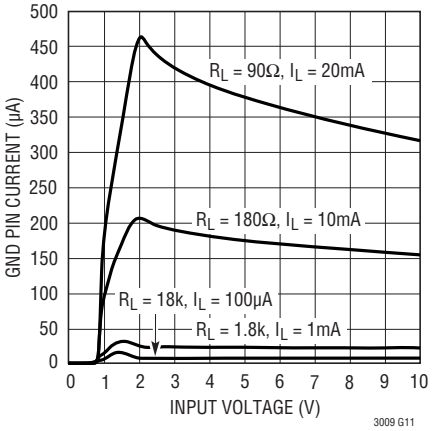


TYPICAL PERFORMANCE CHARACTERISTICS T_A = 25°C, unless otherwise noted.

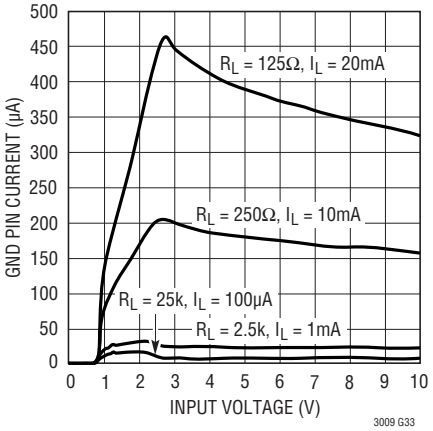
GND Pin Current
LT3009-1.5



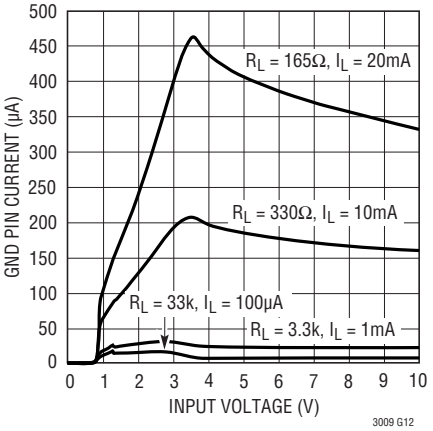
GND Pin Current
LT3009-1.8



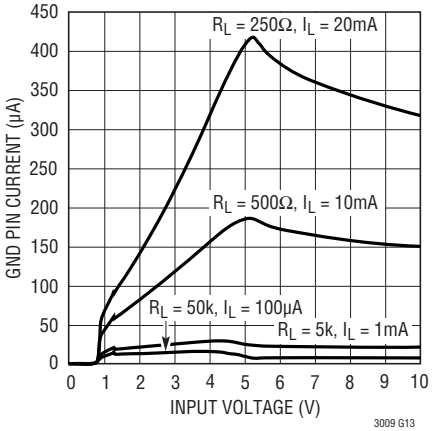
GND Pin Current
LT3009-2.5



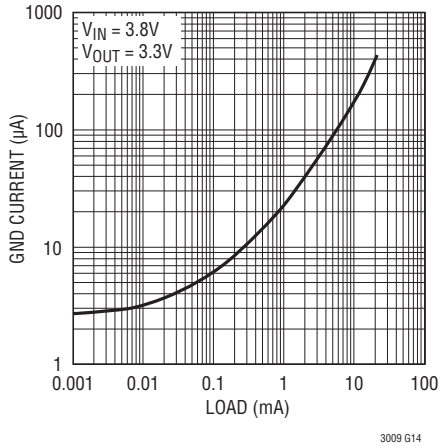
GND Pin Current
LT3009-3.3



GND Pin Current
LT3009-5

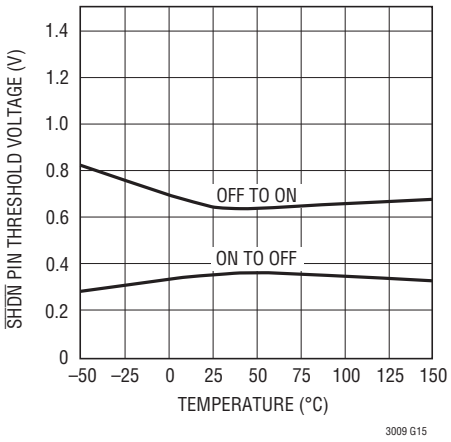


GND Pin Current vs I_{LOAD}

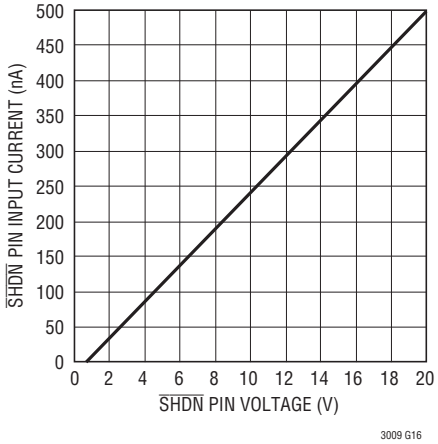


TYPICAL PERFORMANCE CHARACTERISTICS T_A = 25°C, unless otherwise noted.

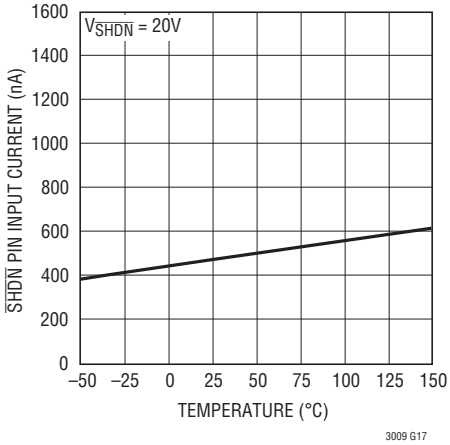
$\overline{SHDN}$ Pin Thresholds



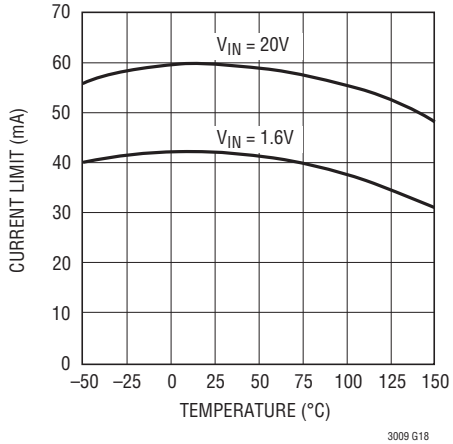
$\overline{SHDN}$ Pin Input Current



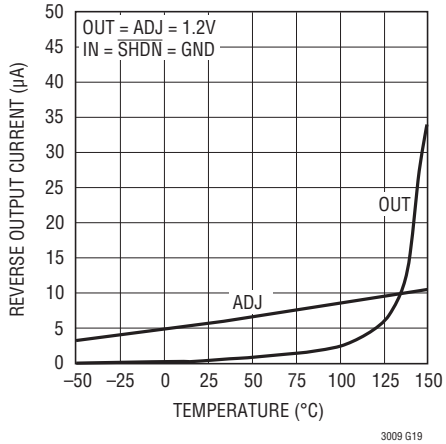
$\overline{SHDN}$ Pin Input Current



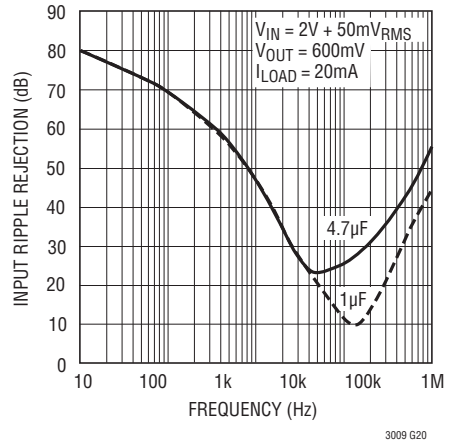
Current Limit



Reverse Output Current

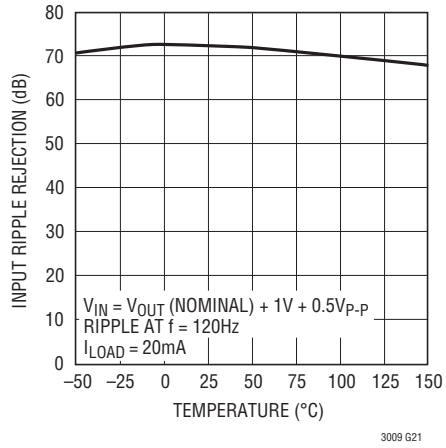


Input Ripple Rejection

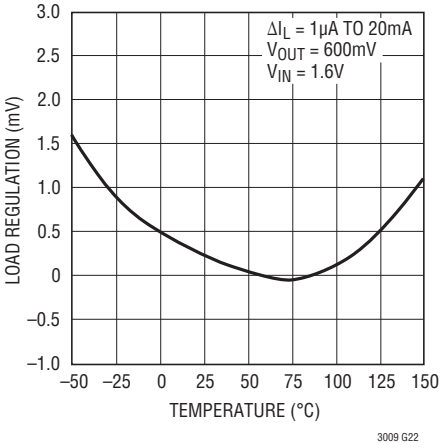


TYPICAL PERFORMANCE CHARACTERISTICS T_A = 25°C, unless otherwise noted.

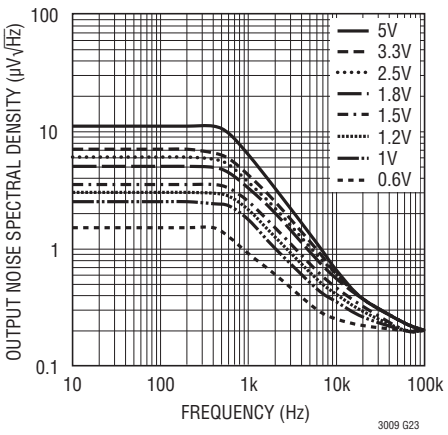
Input Ripple Rejection



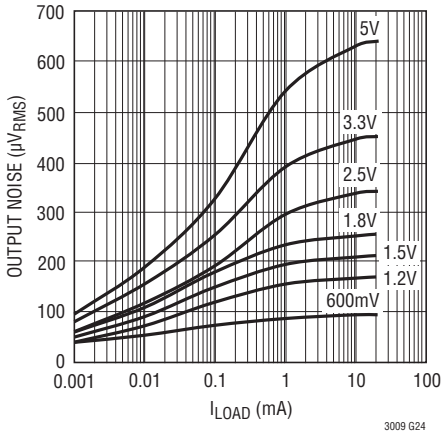
Load Regulation



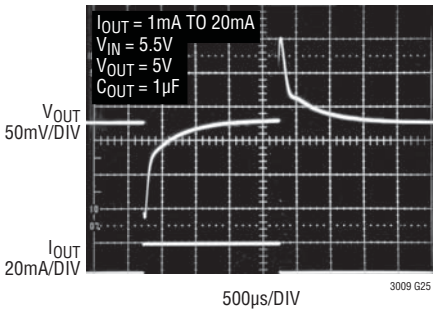
Output Noise Spectral Density



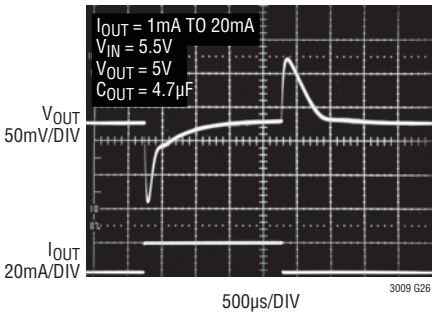
RMS Output Noise vs Load Current (10Hz to 100kHz)



Transient Response



Transient Response



PIN FUNCTIONS (SC70/DFN)

$\overline{\text{SHDN}}$ (Pin 1/Pin 5): Shutdown. Pulling the $\overline{\text{SHDN}}$ pin low puts the LT3009 into a low power state and turns the output off. If unused, tie the $\overline{\text{SHDN}}$ pin to V_{IN}. The LT3009 does not function if the $\overline{\text{SHDN}}$ pin is not connected. The $\overline{\text{SHDN}}$ pin cannot be driven below GND unless tied to the IN pin. If the $\overline{\text{SHDN}}$ pin is driven below GND while IN is powered, the output will turn on. $\overline{\text{SHDN}}$ pin logic cannot be referenced to a negative rail.

GND (Pins 2, 3, 4/Pin 6): Ground. Connect the bottom of the resistor divider that sets output voltage directly to GND for the best regulation.

IN (Pin 5/Pin 4): Input. The IN pin supplies power to the device. The LT3009 requires a bypass capacitor at IN if the device is more than six inches away from the main input filter capacitor. In general, the output impedance of a battery rises with frequency, so it is advisable to include a bypass capacitor in battery-powered circuits. A bypass capacitor in the range of 0.1µF to 10µF will suffice. The LT3009 withstands reverse voltages on the IN pin with respect to ground and the OUT pin. In the case of a reversed input, which occurs with a battery plugged in backwards, the LT3009 acts as if a large resistor is in series with its input. Limited reverse current flows into the LT3009 and no reverse voltage appears at the load. The device protects both itself and the load.

OUT (Pin 6/Pins 2, 3): Output. This pin supplies power to the load. Use a minimum output capacitor of 1µF to prevent oscillations. Large load transient applications require larger output capacitors to limit peak voltage transients. See the Applications Information section for more information on output capacitance and reverse output characteristics.

ADJ (Pin 7/Pin 1): Adjust. This pin is the error amplifier's inverting terminal. Its 300pA typical input bias current flows out of the pin (see curve of ADJ Pin Bias Current vs Temperature in the Typical Performance Characteristics section). The ADJ pin voltage is 600mV referenced to GND and the output voltage range is 600mV to 19.5V. This pin is not connected in the fixed output voltage versions.

NC (Pins 7, 8/Pin 1): No Connect. For the adjustable voltage version, Pin 8 is an NC pin in the SC70 package. For the fixed voltage versions, Pin 7 and Pin 8 are NC pins in the SC70 package, and Pin 1 is an NC pin in the DFN package. NC pins are not tied to any internal circuitry. They may be floated, tied to V_{IN} or tied to GND.

Exposed Pad (Pin 7, DFN Package Only): Ground. The Exposed Pad (backside) of the DFN package is an electrical connection to GND. To ensure optimum performance, solder Pin 7 to the PCB and tie directly to Pin 6.

APPLICATIONS INFORMATION

The LT3009 is a low dropout linear regulator with ultra-low quiescent current and shutdown. Quiescent current is extremely low at 3µA and drops well below 1µA in shutdown. The device supplies up to 20mA of output current. Dropout voltage at 20mA is typically 280mV. The LT3009 incorporates several protection features, making it ideal for use in battery-powered systems. The device protects itself against both reverse-input and reverse-output voltages. In battery backup applications, where a backup battery holds up the output when the input is pulled to ground, the LT3009 acts as if a blocking diode is in series with its output and prevents reverse current flow. In applications where the regulator load returns to a negative supply, the output can be pulled below ground by as much as 22V without affecting startup or normal operation.

Adjustable Operation

The LT3009 has an output voltage range of 0.6V to 19.5V. Figure 1 shows that output voltage is set by the ratio of two external resistors. The IC regulates the output to maintain the ADJ pin voltage at 600mV referenced to ground. The current in R1 equals 600mV/R1 and the current in R2 is the current in R1 minus the ADJ pin bias current. The ADJ pin bias current, typically 300pA at 25°C, flows out of the pin. Calculate the output voltage using the formula in Figure 1. An R1 value of 619k sets the divider current to 0.97µA. Do not make R1's value any greater than 619k to minimize output voltage errors due to the ADJ pin bias current and to insure stability under minimum load conditions. In shutdown, the output turns off and the divider current is zero. Curves of ADJ Pin Voltage vs Temperature and ADJ Pin Bias Current vs Temperature appear in the Typical Performance Characteristics.

Specifications for output voltages greater than 0.6V are proportional to the ratio of the desired output voltage to 0.6V: V_{OUT}/0.6V. For example, load regulation for an output current change of 100µA to 20mA is –0.7mV typical at V_{OUT} = 0.6V. At V_{OUT} = 5V, load regulation is:

$$\frac{5V}{0.6V} \bullet (-0.7mV) = -5.83mV$$

Table 1 shows resistor divider values for some common output voltages with a resistor divider current of about 1µA.

Table 1. Output Voltage Resistor Divider Values

V_{OUT}	R1	R2
1V	604k	402k
1.2V	604k	604k
1.5V	590k	887k
1.8V	590k	1.18M
2.5V	590k	1.87M
3V	590k	2.37M
3.3V	619k	2.8M
5V	590k	4.32M

Because the ADJ pin is relatively high impedance (depending on the resistor divider used), stray capacitances at this pin should be minimized. Special attention should be given to any stray capacitances that can couple external signals onto the ADJ pin producing undesirable output transients or ripple.

Extra care should be taken in assembly when using high valued resistors. Small amounts of board contamination can lead to significant shifts in output voltage. Appropriate post-assembly board cleaning measures should

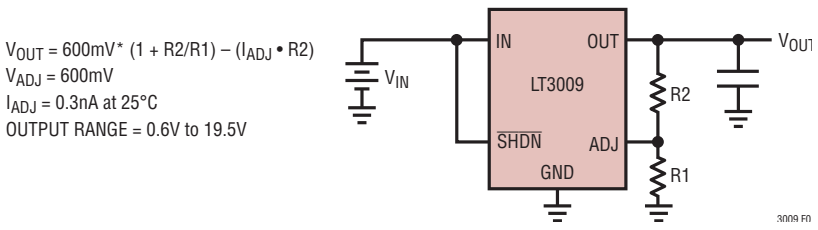


Figure 1. Adjustable Operation

APPLICATIONS INFORMATION

be implemented to prevent board contamination. If the board is to be subjected to humidity cycling or if board cleaning measures cannot be guaranteed, consideration should be given to using resistors an order of magnitude smaller than in Table 1 to prevent contamination from causing unwanted shifts in the output voltage.

Output Capacitance and Transient Response

The LT3009 is stable with a wide range of output capacitors. The ESR of the output capacitor affects stability, most notably with small capacitors. Use a minimum output capacitor of 1µF with an ESR of 3Ω or less to prevent oscillations. The LT3009 is a micropower device and output load transient response is a function of output capacitance. Larger values of output capacitance decrease the peak deviations and provide improved transient response for larger load current changes.

Give extra consideration to the use of ceramic capacitors. Manufacturers make ceramic capacitors with a variety of dielectrics, each with different behavior across temperature and applied voltage. The most common dielectrics are specified with EIA temperature characteristic codes of Z5U, Y5V, X5R and X7R. The Z5U and Y5V dielectrics provide high C-V products in a small package at low cost, but exhibit strong voltage and temperature coefficients as shown in Figures 2 and 3. When used with a 5V regulator, a 16V 10µF Y5V capacitor can exhibit an effective value as low as 1µF to 2µF for the DC bias voltage applied and over the operating temperature range. The X5R and X7R dielectrics yield more stable characteristics and are more suitable for use as the output capacitor. The X7R type has better stability across temperature, while the X5R is less expensive and is available in higher values. One must still exercise care when using X5R and X7R capacitors; the X5R and X7R codes only specify operating temperature range and maximum capacitance change over temperature. Capacitance change due to DC bias with X5R and X7R capacitors is better than Y5V and Z5U capacitors, but can still be significant enough to drop capacitor values below appropriate levels. Capacitor DC bias characteristics tend to improve as component case size increases, but expected capacitance at operating voltage should be verified.

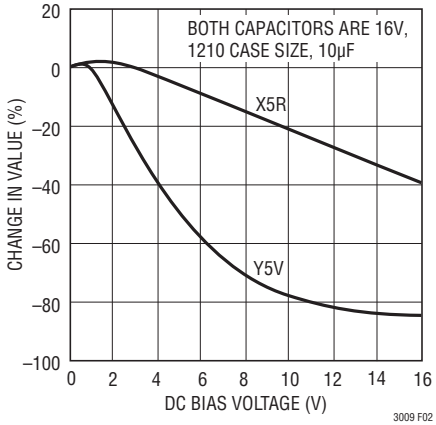


Figure 2. Ceramic Capacitor DC Bias Characteristics

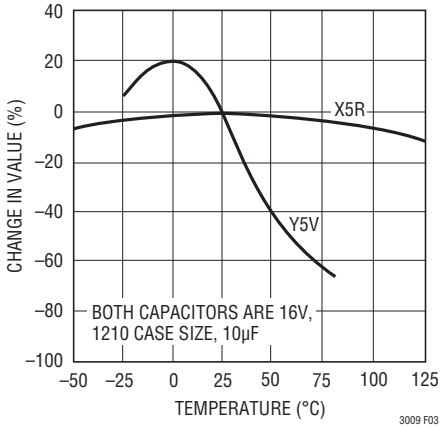


Figure 3. Ceramic Capacitor Temperature Characteristics

APPLICATIONS INFORMATION

Voltage and temperature coefficients are not the only sources of problems. Some ceramic capacitors have a piezoelectric response. A piezoelectric device generates voltage across its terminals due to mechanical stress, similar to the way a piezoelectric accelerometer or microphone works. For a ceramic capacitor, the stress can be induced by vibrations in the system or thermal transients. The resulting voltages produced can cause appreciable amounts of noise, especially when a ceramic capacitor is used for noise bypassing. A ceramic capacitor produced Figure 4's trace in response to light tapping from a pencil. Similar vibration induced behavior can masquerade as increased output voltage noise.

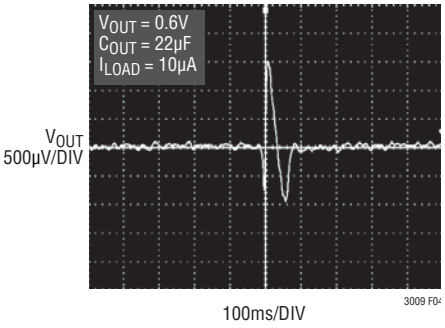


Figure 4. Noise Resulting from Tapping on a Ceramic Capacitor

Thermal Considerations

The LT3009's maximum rated junction temperature of 125°C limits its power-handling capability. Two components comprise the power dissipated by the device:

1. Output current multiplied by the input/output voltage differential: $I_{OUT} \bullet (V_{IN} – V_{OUT})$
2. GND pin current multiplied by the input voltage: $I_{GND} \bullet V_{IN}$

GND pin current is found by examining the GND Pin Current curves in the Typical Performance Characteristics section. Power dissipation equals the sum of the two components listed prior.

The LT3009 regulator has internal thermal limiting designed to protect the device during overload conditions. For continuous normal conditions, do not exceed the maximum junction temperature rating of 125°C. Carefully consider all sources of thermal resistance from junction to ambient including other heat sources mounted in proximity to the LT3009. For surface mount devices, heat sinking is accomplished by using the heat spreading capabilities of the PC board and its copper traces. Copper board stiffeners and plated through-holes can also be used to spread the heat generated by power devices.

APPLICATIONS INFORMATION

The following tables list thermal resistance for several different board sizes and copper areas. All measurements were taken in still air on 3/32" FR-4 board with one ounce copper.

Table 2: Measured Thermal Resistance for DC Package

COPPER AREA		BOARD AREA	THERMAL RESISTANCE (JUNCTION-TO-AMBIENT)
TOPSIDE*	BACKSIDE		
2500mm^2	2500mm^2	2500mm^2	65°C/W
1000mm^2	2500mm^2	2500mm^2	70°C/W
225mm^2	2500mm^2	2500mm^2	75°C/W
100mm^2	2500mm^2	2500mm^2	80°C/W
50mm^2	2500mm^2	2500mm^2	85°C/W

*Device is mounted on the topside.

Table 3: Measured Thermal Resistance for SC70 Package

COPPER AREA		BOARD AREA	THERMAL RESISTANCE (JUNCTION-TO-AMBIENT)
TOPSIDE*	BACKSIDE		
2500mm^2	2500mm^2	2500mm^2	75°C/W
1000mm^2	2500mm^2	2500mm^2	80°C/W
225mm^2	2500mm^2	2500mm^2	85°C/W
100mm^2	2500mm^2	2500mm^2	90°C/W
50mm^2	2500mm^2	2500mm^2	95°C/W

*Device is mounted on the topside.

Calculating Junction Temperature

Example: Given an output voltage of 3.3V, an input voltage range of 12V ±5%, an output current range of 0mA to 20mA and a maximum ambient temperature of 85°C, what will the maximum junction temperature be for an application using the DC package?

The power dissipated by the device is equal to:

$$I_{OUT(MAX)} (V_{IN(MAX)} - V_{OUT}) + I_{GND} (V_{IN(MAX)})$$

where,

$I_{OUT(MAX)} = 20mA$

$V_{IN(MAX)} = 12.6V$

I_{GND} at ($I_{OUT} = 20mA$, $V_{IN} = 12.6V$) = 0.45mA

So,

$P = 20mA(12.6V - 3.3V) + 0.45mA(12.6V) = 191.7mW$

The thermal resistance will be in the range of 65°C/W to 85°C/W depending on the copper area. So the junction temperature rise above ambient will be approximately equal to:

$0.1917W(75°C/W) = 14.4°C$

The maximum junction temperature equals the maximum junction temperature rise above ambient plus the maximum ambient temperature or:

$T_{J(MAX)} = 85°C + 14.4°C = 99.4°C$

APPLICATIONS INFORMATION

Protection Features

The LT3009 incorporates several protection features that make it ideal for use in battery-powered circuits. In addition to the normal protection features associated with monolithic regulators, such as current limiting and thermal limiting, the device also protects against reverse-input voltages, reverse-output voltages and reverse output-to-input voltages.

Current limit protection and thermal overload protection protect the device against current overload conditions at the output of the device. For normal operation, do not exceed a junction temperature of 125°C.

The LT3009 IN pin withstands reverse voltages of 22V. The device limits current flow to less than 1mA (typically less than 220µA) and no negative voltage appears at OUT. The device protects both itself and the load against batteries that are plugged in backwards.

The $\overline{SHDN}$ pin cannot be driven below GND unless tied to the IN pin. If the $\overline{SHDN}$ pin is driven below GND while IN is powered, the output will turn on. $\overline{SHDN}$ pin logic cannot be referenced to a negative rail.

The LT3009 incurs no damage if OUT is pulled below ground. If IN is left open circuit or grounded, OUT can be pulled below ground by 22V. No current flows from the pass transistor connected to OUT. However, current flows in (but is limited by) the resistor divider that sets output voltage. Current flows from the bottom resistor in the divider and from the ADJ pin's internal clamp through the top resistor in the divider to the external circuitry pulling OUT below ground. If IN is powered by a voltage source, OUT sources current equal to its current limit capability and the LT3009 protects itself by thermal limiting if necessary. In this case, grounding the $\overline{SHDN}$ pin turns off the LT3009 and stops OUT from sourcing current.

The LT3009 incurs no damage if the ADJ pin is pulled above or below ground by 22V. If IN is left open circuit or grounded, ADJ acts like a 100k resistor in series with a diode when pulled above or below ground.

In circuits where a backup battery is required, several different input/output conditions can occur. The output voltage may be held up while the input is either pulled to ground, pulled to some intermediate voltage or is left open circuit. Current flow back into the output follows the curve shown in Figure 5.

If the LT3009 IN pin is forced below the OUT pin or the OUT pin is pulled above the IN pin, input current typically drops to less than 1µA. This occurs if the LT3009 input is connected to a discharged (low voltage) battery and either a backup battery or a second regulator circuit holds up the output. The state of the $\overline{SHDN}$ pin has no effect in the reverse current if OUT is pulled above IN.

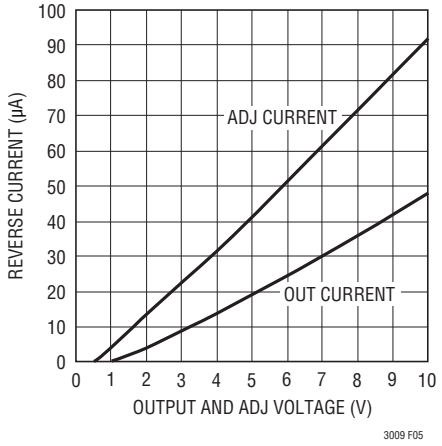
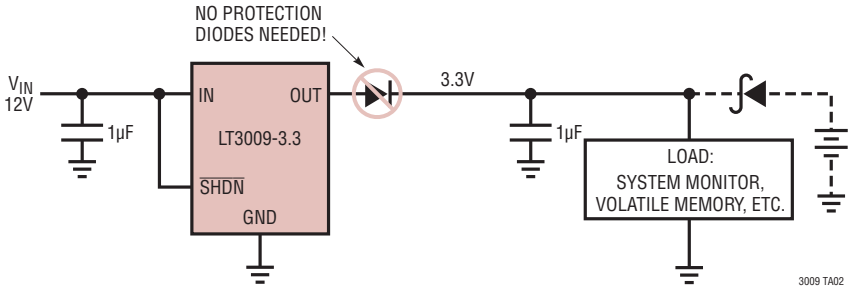


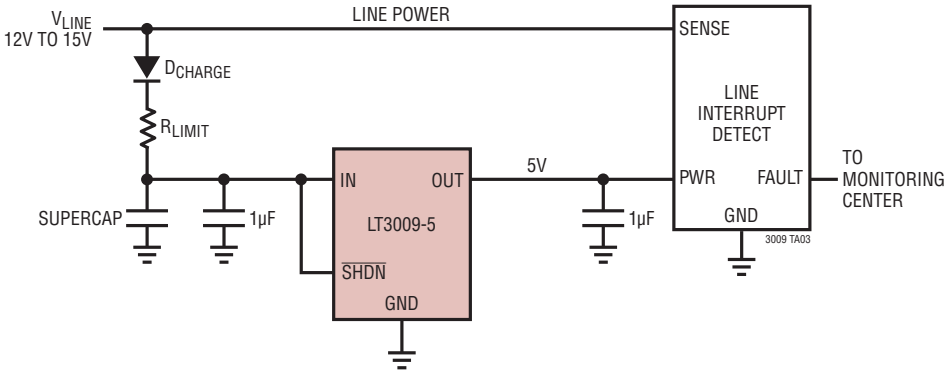
Figure 5. Reverse Output Current

TYPICAL APPLICATIONS

Keep-Alive Power Supply

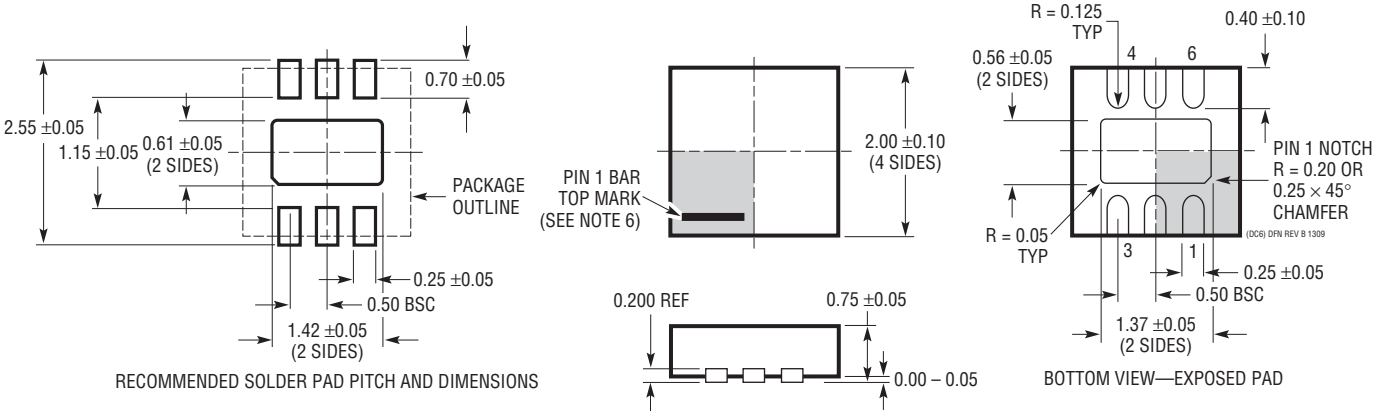


Last-Gasp Circuit



PACKAGE DESCRIPTION

DC6 Package
6-Lead Plastic DFN (2mm × 2mm)
(Reference LTC DWG # 05-08-1703 Rev B)

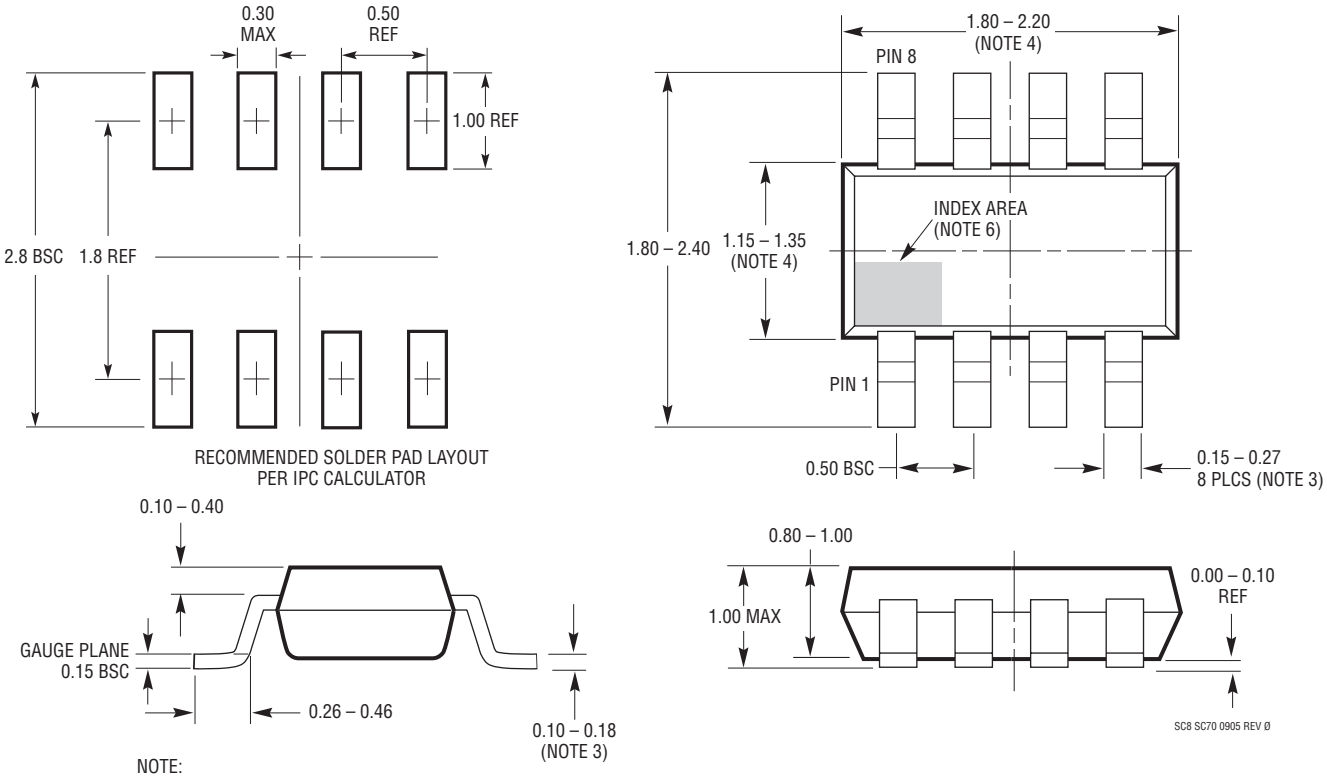


NOTE:
1. DRAWING TO BE MADE A JEDEC PACKAGE OUTLINE M0-229 VARIATION OF (WCCD-2)
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS
4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

PACKAGE DESCRIPTION

SC8 Package
8-Lead Plastic SC70
(Reference LTC DWG # 05-08-1639 Rev Ø)



NOTE:
1. DIMENSIONS ARE IN MILLIMETERS
2. DRAWING NOT TO SCALE
3. DIMENSIONS ARE INCLUSIVE OF PLATING
4. DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH AND METAL BURR
5. MOLD FLASH SHALL NOT EXCEED 0.254mm
6. DETAILS OF THE PIN 1 IDENTIFIER ARE OPTIONAL,
   BUT MUST BE LOCATED WITHIN THE INDEX AREA
7. EIAJ PACKAGE REFERENCE IS EIAJ SC-70 AND JEDEC MO-203 VARIATION BA

REVISION HISTORY (Revision history begins at Rev D)

REV	DATE	DESCRIPTION	PAGE NUMBER
D	04/12	Clarified E-Grade Operating Temperature	5

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1761	100mA, Low Noise Micropower LDO	V_{IN}: 1.8V to 20V, V_{OUT} = 1.22V, V_{DO} = 0.3V, I_Q = 20µA, I_{SD} < 1µA, Low Noise < 20µV_{RMS}, Stable with 1µF Ceramic Capacitors, ThinSOT™ Package
LT1762	150mA, Low Noise Micropower LDO	V_{IN}: 1.8V to 20V, V_{OUT} = 1.22V, V_{DO} = 0.3V, I_Q = 25µA, I_{SD} < 1µA, Low Noise < 20µV_{RMS}, MS8 Package
LT1763	500mA, Low Noise Micropower LDO	V_{IN}: 1.8V to 20V, V_{OUT} = 1.22V, V_{DO} = 0.3V, I_Q = 30µA, I_{SD} < 1µA, Low Noise < 20µV_{RMS}, S8 Package
LT1764/LT1764A	3A, Low Noise, Fast Transient Response LDOs	V_{IN}: 2.7V to 20V, V_{OUT} = 1.21V, V_{DO} = 0.34V, I_Q = 1mA, I_{SD} < 1µA, Low Noise < 40µV_{RMS}, "A" Version Stable with Ceramic Capacitors, DD and TO220-5 Packages
LTC1844	150mA, Low Noise Micropower VLDO	V_{IN}: 1.6V to 6.5V, $V_{OUT(MIN)}$ = 1.25V, V_{DO} = 0.09V, I_Q = 35µA, I_{SD} < 1µA, Low Noise: < 30µV_{RMS}, ThinSOT Package
LT1962	300mA, Low Noise Micropower LDO	V_{IN}: 1.8V to 20V, $V_{OUT(MIN)}$ = 1.22V, V_{DO} = 0.27V, I_Q = 30µA, I_{SD} < 1µA, Low Noise: < 20µV_{RMS}, MS8 Package
LT1963/LT1963A	1.5A, Low Noise, Fast Transient Response LDOs	V_{IN}: 2.1V to 20V, $V_{OUT(MIN)}$ = 1.21V, V_{DO} = 0.34V, I_Q = 1mA, I_{SD} < 1µA, Low Noise: < 40µV_{RMS}, "A" Version Stable with Ceramic Capacitors, DD, TO220-5, SOT223 and S8 Packages
LT1964	200mA, Low Noise Micropower, Negative LDO	V_{IN}: –2.2V to –20V, $V_{OUT(MIN)}$ = 1.21V, V_{DO} = 0.34V, I_Q = 30µA, I_{SD} = 3µA, Low Noise: < 30µV_{RMS}, Stable with Ceramic Capacitors,ThinSOT Package
LT3010	50mA, High Voltage, Micropower LDO	V_{IN}: 3V to 80V, $V_{OUT(MIN)}$ = 1.275V, V_{DO} = 0.3V, I_Q = 30µA, I_{SD} < 1µA, Low Noise: < 100µV_{RMS}, Stable with 1µF Output Capacitor, MS8E Package
LT3012/LT3012B	250mA, High Voltage, Micropower LDOs	V_{IN}: 4V to 80V, $V_{OUT(MIN)}$ = 1.24V, V_{DO} = 0.4V, I_Q = 40µA, I_{SD} < 1µA, Low Noise: <100µV_{RMS}, Stable with 3.3µF Output Capacitor, 12-Lead 4mm × 3mm DFN and 16-Lead FE Packages
LT3013/LT3013B	250mA, High Voltage, Micropower LDOs with PWRGD	V_{IN}: 4V to 80V, $V_{OUT(MIN)}$ = 1.22V, V_{DO} = 0.4V, I_Q = 40µA, I_{SD} < 1µA, Low Noise: < 100µV_{RMS}, Stable with 3.3µF Output Capacitor, 12-Lead 4mm × 3mm DFN and 16-Lead FE Packages
LT3014/LT3014B	20mA, High Voltage, Micropower LDO	V_{IN}: 3V to 80V, $V_{OUT(MIN)}$ = 1.2V, V_{DO} = 0.35V, I_Q = 7µA, I_{SD} < 1µA, Low Noise: < 100µV_{RMS}, Stable with 0.47µF Output Capacitor, SOT23-5 and 3mm × 3mm DFN Packages
LT3020	100mA, Low Voltage VLDO	V_{IN}: 0.9V to 10V, $V_{OUT(MIN)}$ = 0.20V, V_{DO} = 0.15V, I_Q = 120µA, I_{SD} < 1µA, 3mm × 3mm DFN and MS8 Packages
LT3021	500mA, Low Voltage VLDO	V_{IN}: 0.9V to 10V, $V_{OUT(MIN)}$ = 0.20V, V_{DO} = 0.16V, I_Q = 120µA, I_{SD} < 3µA, 5mm × 5mm DFN and SO8 Packages
LT3023	Dual 100mA, Low Noise, Micropower LDO	V_{IN}: 1.8V to 20V, $V_{OUT(MIN)}$ = 1.22V, V_{DO} = 0.30V, I_Q = 40µA, I_{SD} < 1µA, DFN and MS10 Packages
LT3024	Dual 100mA/500mA, Low Noise, Micropower LDO	V_{IN}: 1.8V to 20V, $V_{OUT(MIN)}$ = 1.22V, V_{DO} = 0.30V, I_Q = 60µA, I_{SD} < 1µA, DFN and TSSOP-16E Packages
LTC3025	300mA, Low Voltage Micropower VLDO	45mV Dropout Voltage, Low Noise 110µV_{RMS}, V_{IN} = 1.14V to 5.5V, Low I_Q: 54µA, 6-Lead 2mm × 2mm DFN Package
LTC3026	1.5A, Low Input Voltage VLDO	100mV Dropout Voltage, Low Noise 80µV_{RMS}, V_{IN} = 0.9V to 5.5V, Low I_Q: 950µA, 10-Lead 3mm × 3mm DFN and MS10E Packages
LT3027	Dual 100mA, Low Noise, Micropower LDO with Independent Inputs	V_{IN}: 1.8V to 20V, $V_{OUT(MIN)}$ = 1.22V, V_{DO} = 0.30V, I_Q = 40µA, I_{SD} < 1µA, DFN and MS10E Packages
LT3028	Dual 100mA/500mA, Low Noise, Micropower LDO with Independent Inputs	V_{IN}: 1.8V to 20V, $V_{OUT(MIN)}$ = 1.22V, V_{DO} = 0.30V, I_Q = 60µA, I_{SD} < 1µA, DFN and TSSOP-16E Packages

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